

# INTERNATIONAL CMOS TECHNOLOGY, INC.

# 27CX321/27CX322 4,096 x 8-bit CMOS High-Speed Erasable PROM

#### **Features**

## Advanced CMOS EPROM Technology

#### ■ High Performance

- 27CX321/322-35 tAA = 35nS max
- 27CX321/322-40 tAA = 40nS max
- 27CX321/322-45 taa = 45nS max

### **■ Low Power Consumption**

- Icc = 40mA max Active (Commercial)
- IsB = 500μA max typical Standby Mode

#### **■ TTL-Compatible I/O**

#### ■ Reprogrammability

- Adds convenience, reduces costs
- Windowed package for UV erasure
- Allows 100% factory testing

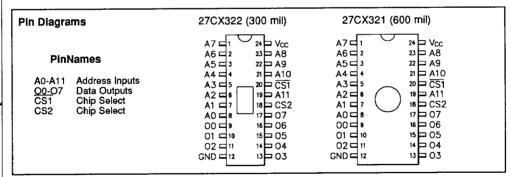
#### ■ Bipolar PROM replacement

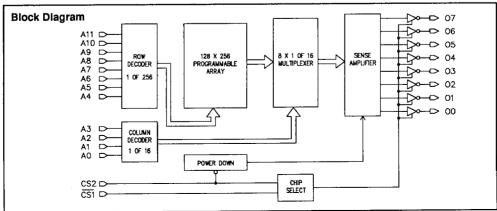
- Pin-compatible with Bipolar PROMs
- Higher speed
- Lower power consumption
- 300-mil and 600-mil packages
- Commercial and Industrial Versions

## **General Description**

The ICT 27CX321 and 27CX322 are 4,096 X 8-bit CMOS high-speed UV-erasable PROMs that provide a low-power, reprogrammable alternative to bipolar fuse-link PROMs. Available in both 600mil (27CX321) and 300mil (27CX322) packages, these devices are pin/socket-compatible with many popular bipolar PROMs. The 27CX321/322 are designed in an advanced CMOS EPROM technology and use differential memory-cell techniques to provide access times comparable to high-speed

bipolar PROMs (as fast as 35nS), with a significant improvement in power consumption. A special, user-programmable, low-power standby mode reduces power consumption even further when the device is deselected. The reprogrammability of the 27CX321/322 not only adds convenience and reduces development and field retrofit costs, but enhances factory testability, allowing for 100% field programmability and function.







## 27CX321/27CX322

## **Absolute Maximum Ratings**

Exposure to absolute maximum ratings over extended periods of time may affect device reliability. Exceeding absolute maximum ratings may cause permanent damage.

Symbol	Parameter	Conditions	Rating	Unit
Vcc	Supply Voltage	Relative to GND	- 0.6 to +7.0	V
Vio	Voltage Applied to Any Pin	Relative to GND	-0.6 to Vcc+0.6	٧
TA	Ambient Temp., Power Applied		-10 to +85	ċ
Tst	Storage Temperature		-65 to +150	.c
TLT	Lead Temperature	Soldering 10 seconds	+ 300	.c

## **Operating Ranges**

Symbol	Parameter	Conditions	Min	Max	Unit
Vcc	Supply Voltage	Commercial	4.75	5.25	٧
Vcc	Supply Voltage	Industrial	4.50	5.50	V
TA	Ambient Temperature	Comercial	0	70	.c
TA	Ambient Temperature	Industrial	-40	85	.c

## **D.C. Electrical Characteristics**

Over the operating range

Symbol	Parameter Conditions		Min	Max	Unit	
ViH	Input HIGH Level		2.0(2.4)		٧	
VIL	Input LOW Level			0.8	٧	
Vон	Output HIGH Voltage <sup>2</sup>	Vcc = Min, IoH = -4.0mA	2.4		٧	
Vol	Output LOW Voltage <sup>2</sup>	Vcc = Min, IoL = 12mA		0.45	٧	
l <u>L</u>	Input Leakage Current	Vcc = Max, GND ≤ V <sub>I</sub> ≤ Vcc		10	μA	
los	Output Short Circuit Current <sup>3</sup>	Vcc = Max, Vo = GND CS1 = V <sub>IL</sub> and CS2 = V <sub>IH</sub>	-15	-90	mA	
ľðz	Output Leakage Current	Vcc = Max, Vo = Vcc or GND CS1 V <sub>IH</sub> or CS2 = V <sub>IL</sub>		10	μA	
lcc	Power Supply Current	All inputs=(GND or Vcc) ±		40(60) <sup>1</sup>	mA	
ISB	Standby Power Supply Current <sup>4</sup> (Typical values ~ 500μA)	CS2 = V <sub>IL</sub> , All other inputs = (GND or Vcc) ± 0.3V	0.1	5	mA	
Vic	Input Clamp Voltage	Vcc = Min, I <sub>IN</sub> = -18mA		-1.2	٧	

## Capacitance

These measurements are periodically sample tested...

Symbol	Parameter Conditions		Min	Max	Unit
CIN	Input Capacitance	T <sub>A</sub> = 25°C V <sub>CC</sub> = 5.0V @ f = 1MHz		6	pF
Соит	Output Capacitance			12	pF
Ccs <sub>1</sub>	CS1 Pin Capacitance			15	рF
C <sub>CS2</sub>	CS2 Pin Capacitance			6	pF

#### Notes:

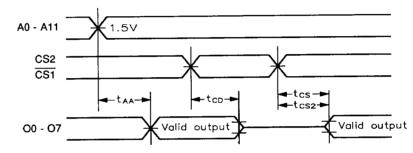
- 1. Industrial specification.
- 2. The 27CX321/27CX322 provide true CMOS output interface levels. The specifications shown are for TTL interface.
- 3. No more than one output should be shorted at a time. Duration of short circuit should not be more than one second.
- 4. Applicable only if standby mode is programmed.

#### A.C. Electrical Characteristics

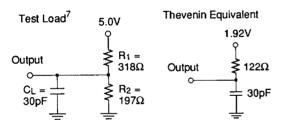
Over the Operating Range 5

Symbol	Parameter	27CX321-35		27CX321-40		27CX321-45		Unit
		Min	Max	Min	Мах	Min	Max	
taa	Access Time From Address To Output		35		40		45	nS
tcs	Access Time From Chip Select 1 or 2 to Output 5		20		25		25	nS
tcs2	Chip Select 2 to Output in Standby Mode 4,6		30		30		35	nS
tcp	Chip Select 1 and 2 Disable to High-Z <sup>6,7</sup>		20		20		25	nS

## **Switching Waveforms**



#### **Test Loads**



#### Notes:

- Test conditions assume: signal transition times of 5 nS or less from the 10% and 90% points; timing reference levels of 1.5V (unless otherwise specified); and test loads shown.
- tcs and tcs2 are measured from the input transition to V<sub>REF</sub> ± 0.1V. tcp is measured from the input transition to V<sub>OH</sub> – 0.1V or V<sub>OL</sub> + 0.1V.
- C<sub>L</sub> includes scope and jig capacitance, t<sub>CD</sub> is tested with C<sub>L</sub> = 5pF.

## Standby Low-Power Mode

The low-power standby mode is a user-selectable option that can be set using programming equipment that supports the 27CX321/27CX322. If this mode is set, the 27CX321/27CX322 will power-down to typically 500µA supply current while CS2 is asserted low. The delay from CS2 low to power-down is approximately 45nS. Note that chip-select-to-data-out timing for CS2 will change if the standby mode is selected (refer to the specification for tcs2 under A.C. Electrical Characteristics). For information on selecting the standby option, please contact your programmer manufacturer or ICT.

## **Erasure Characteristics**

The 27CX321/27CX322 are erased by exposure to ultraviolet light. For complete erasure, the recommended minimum integrated dose (UV intensity X exposure time) is 15 Watt-second/cm<sup>2</sup> of ultraviolet light with a wavelength of 2537Å. For an ultraviolet

lamp with a 12mW/cm² power rating, the exposure time would be approximately 20 minutes. The 27CX321/27CX322 should be placed within one inch of the lamp during erasure. Exposing the CMOS EPROM to high-intensity UV light for extended periods may affect device reliability

## Programming the 27CX321/322

The 27CX321/27CX322 employ a dual-transistor differential memory cell design. Initially, and after erasure, all bits of the 27CX321/322 are in an undefined state. Thus, verifying a blank device will yield erroneous results. The desired state of each bit must be programmed into the device to ensure proper operation.

Programming support is available from ICT and third-party vendors, including DATA I/O (model no. 29B with Unipak 2 or 2B - firmware version V15). For more information on programming support and programming specifications, please contact ICT.